

FIG. 1

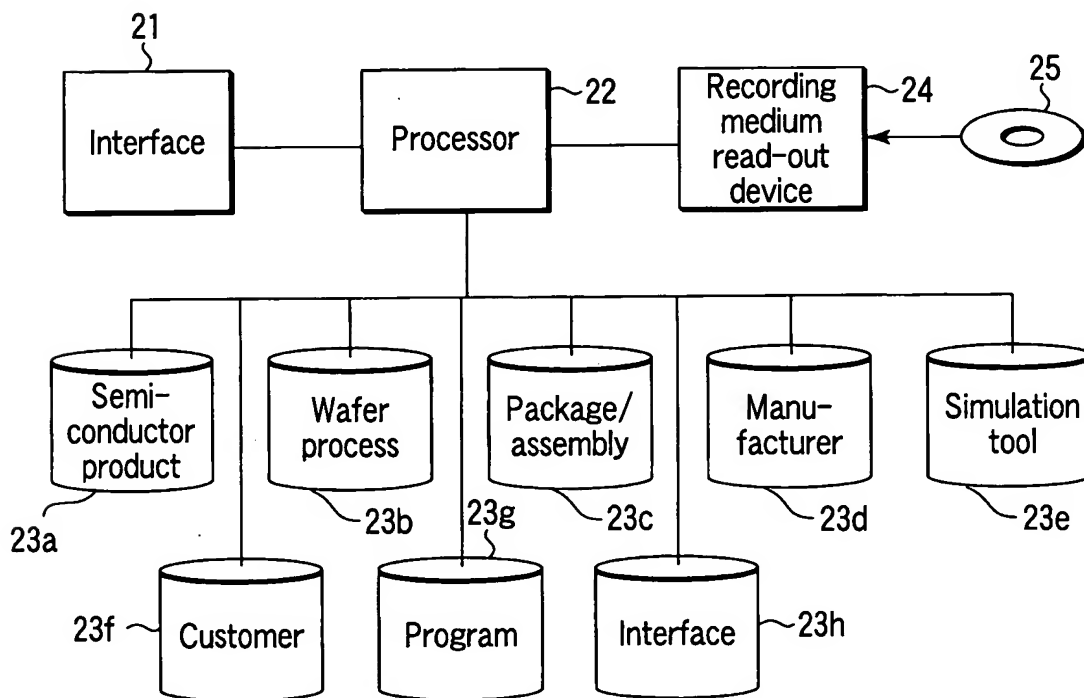


FIG. 2

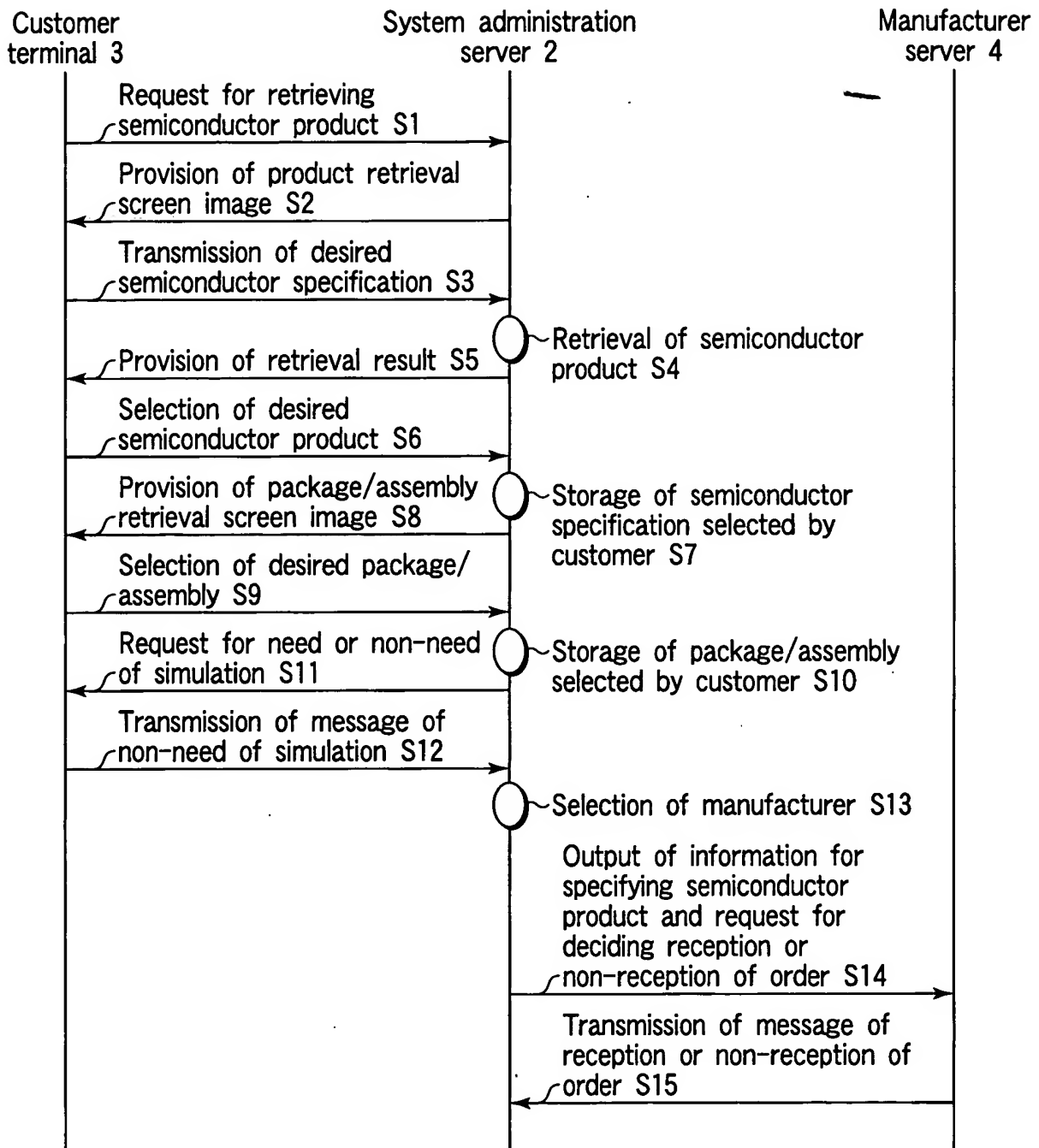


FIG. 3

20250206 62525007

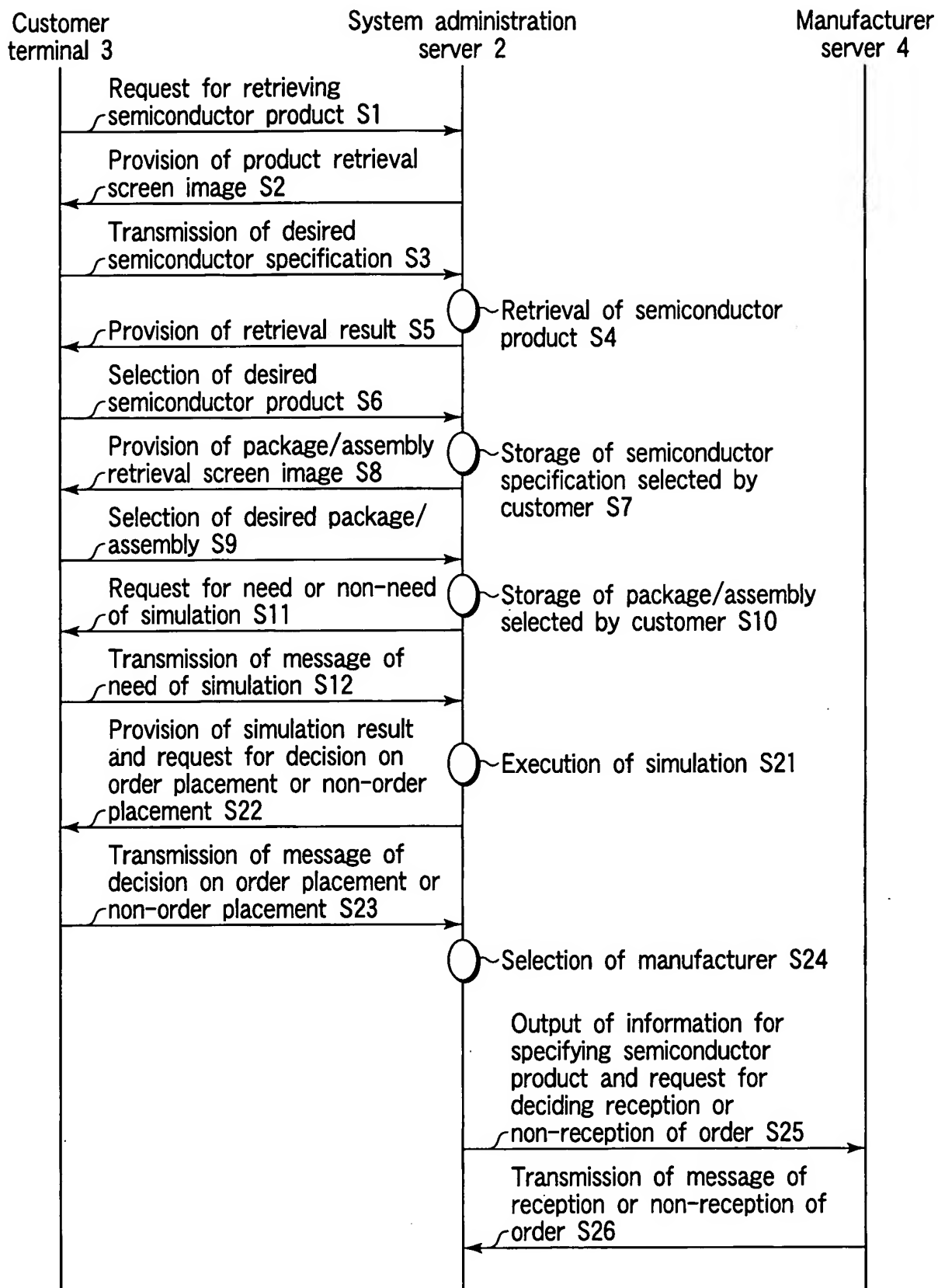


FIG. 4

Select type of semiconductor product.

Also select specification of device you want to by selected from list of typical devices below.

Memory

Logic

System LSI

Others

Input necessary specification.

Operation frequency

MHz~

MHz

Cost

¥

~

¥

Delivery date

Not later than (month), (day)

OK

Cancel

FIG.5

Select product conforming to your specification form
semiconductor products listed below.

System LSI, 800MHz

System LSI, 833MHz

System LSI, 850MHz

OK

Cancel

FIG. 6

Size

External form

Package type

Package structure

Inner lead bonding modes

Packing type for shipment

mm2

~

mm2

☐BGA

☐Single chip

☐Single layer

☐C4

☐DIP

☐Multi-chip

☐Multilayer

☐TAB

☐Wire

OK

Cancel

FIG.7

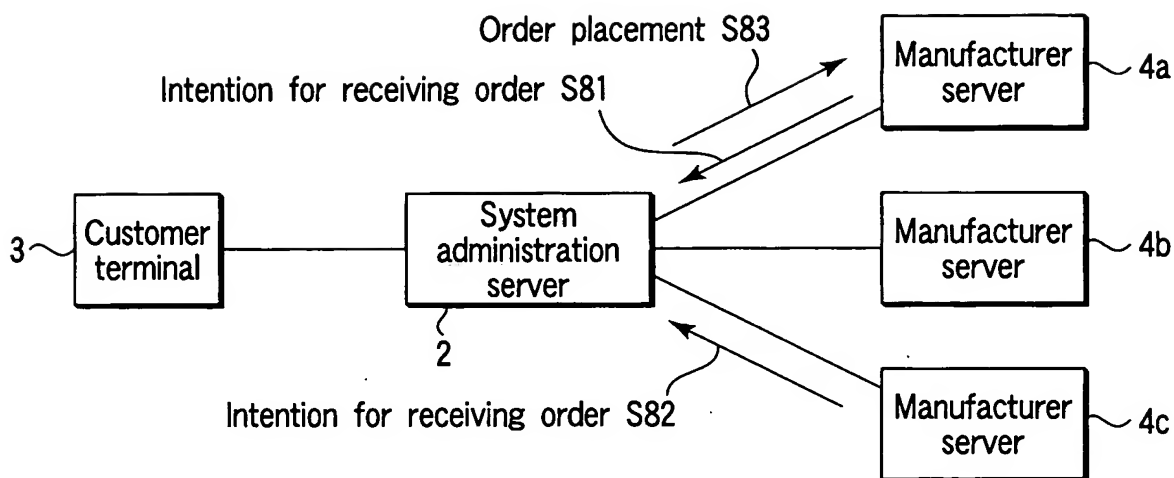


FIG. 8

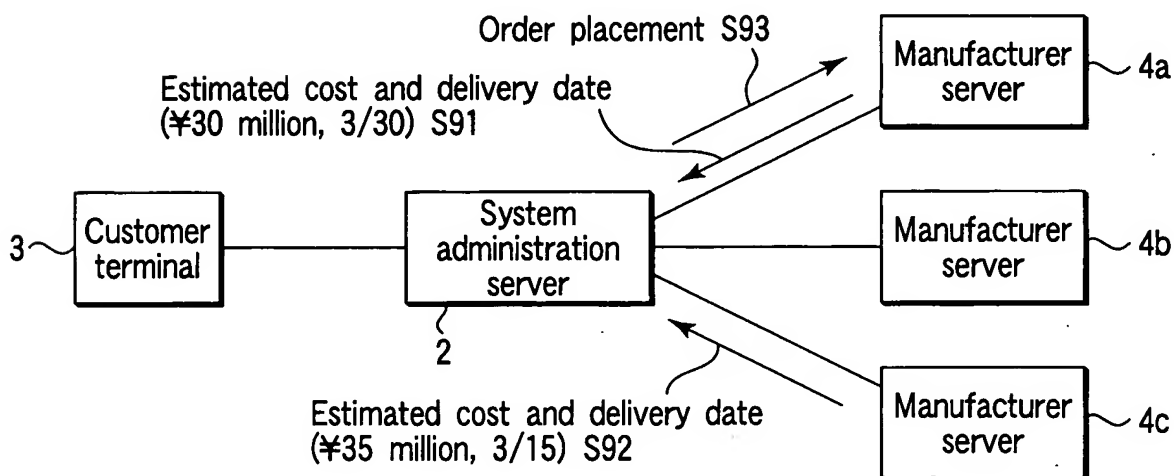


FIG. 9

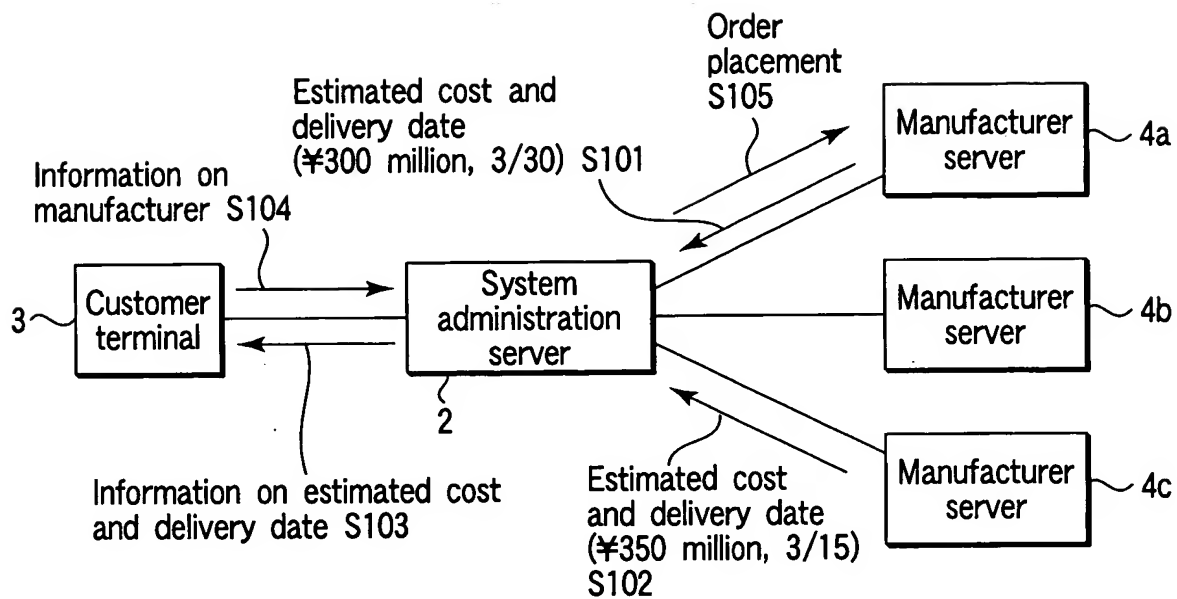
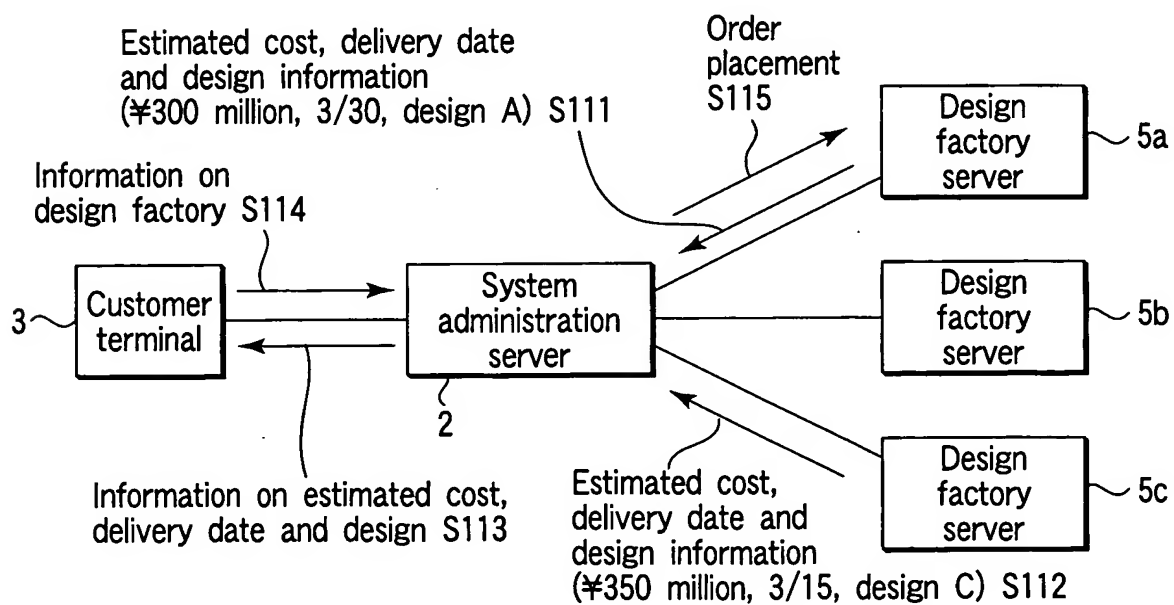
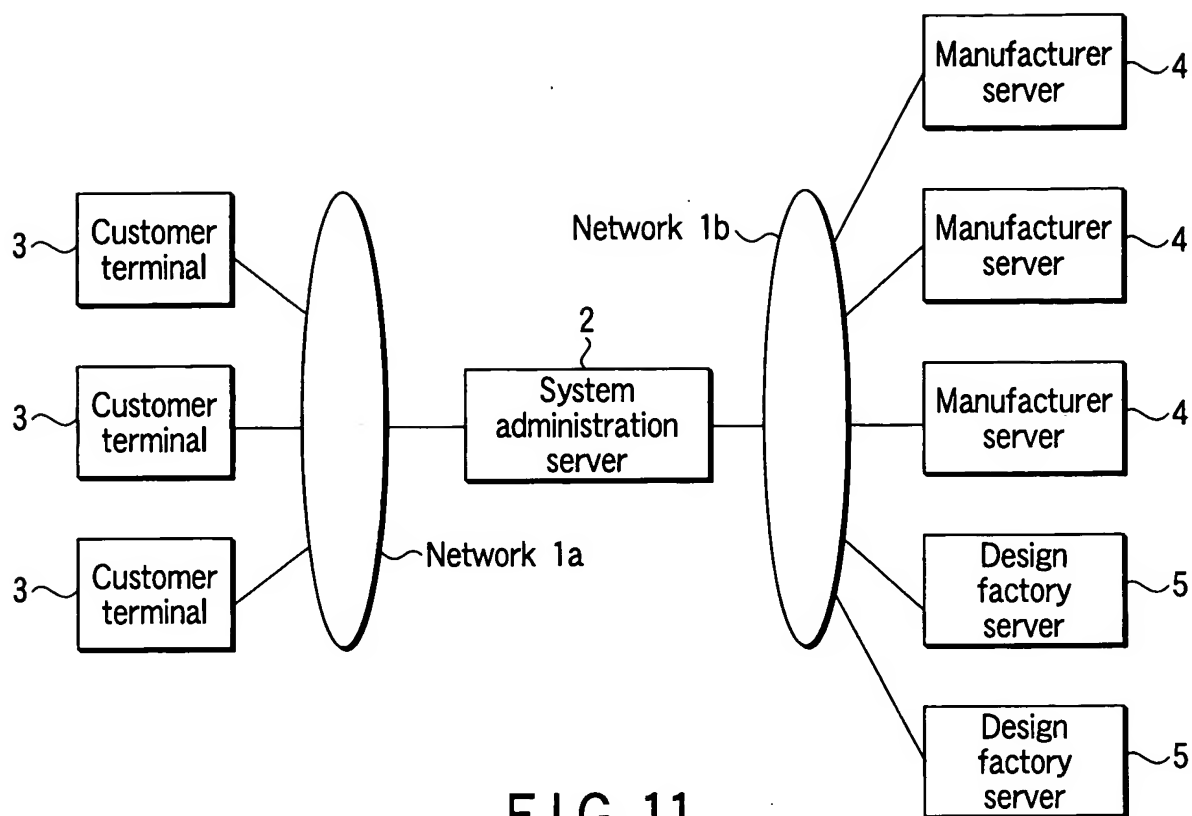


FIG. 10



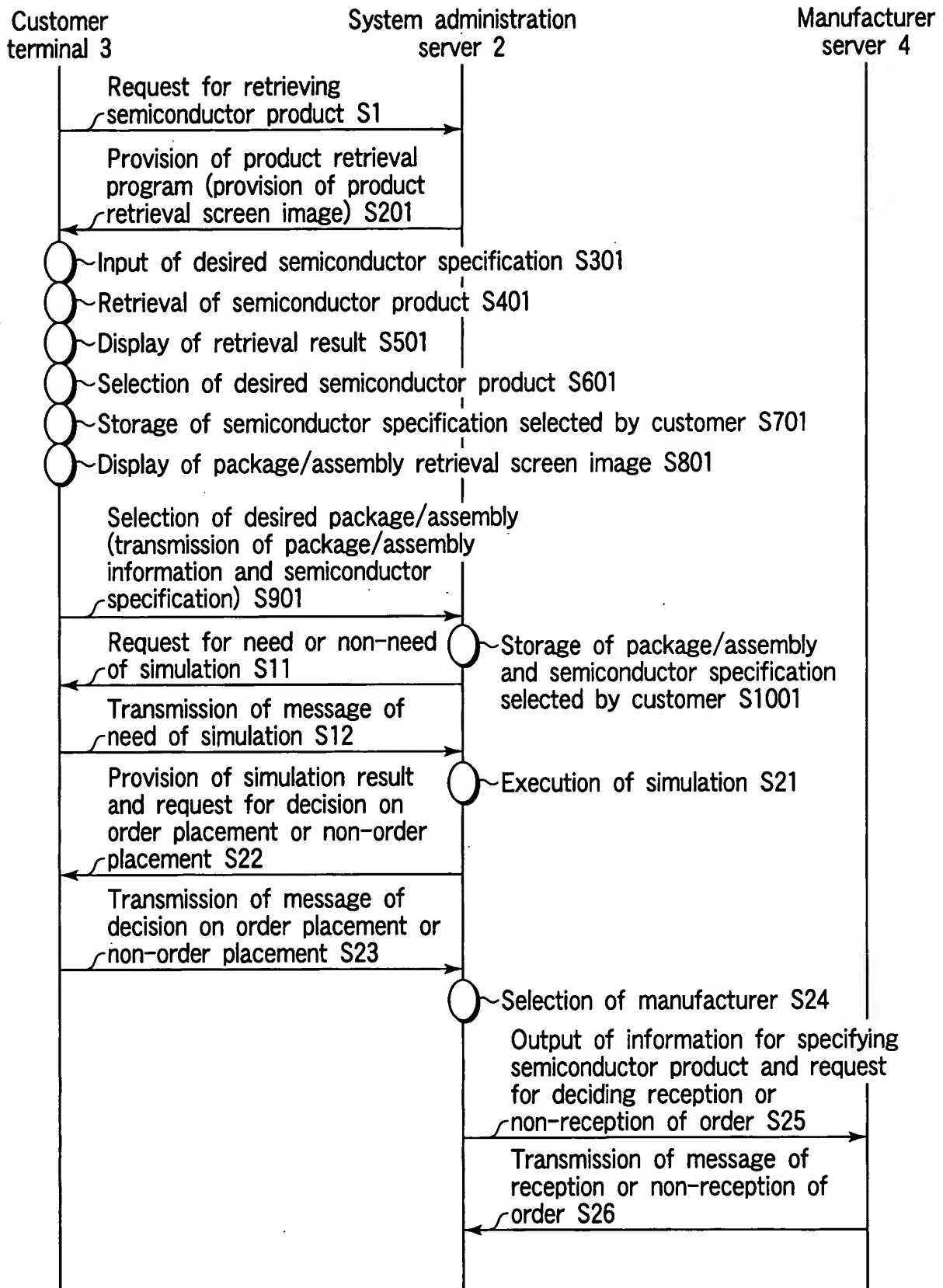


FIG. 13